



Attorney's Docket No.: 12816-021001 / S1166 SB/flu

AF/2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Detlef Weber
Serial No. : 09/898,909
Filed : July 3, 2001
Title : METALLIZATION ARRANGEMENT FOR SEMICONDUCTOR STRUCTURE
AND CORRESPONDING FABRICATION METHOD

Art Unit : 2814
Examiner : P. Cao

MAIL STOP AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT IN REPLY TO ACTION OF JULY 9, 2003

Please amend the above-identified application as follows:

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SEP 16 2003
TECHNOLOGY CENTER 2800

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 9, 2003

Date of Deposit

Signature

Stefanie Dion

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